

Features

- Interdigitated amplifying gates
- Fast turn-on and high di/dt
- Low switching losses

Typical Applications

- Inductive heating
- Electronic welders
- Self-commutated inverters

$I_{T(AV)}$	1660A
V_{DRM}/V_{RRM}	800~1800V
t_q	18~50μs
I_{TSM}	18 kA
I^2t	1620 10³A²S



SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _f (°C)	VALUE			UNIT
				Min	Type	Max	
$I_{T(AV)}$	Mean on-state current	180° half sine wave 50Hz Double side cooled,	T _c =55°C	125		1660	A
V_{DRM} V_{RRM}	Repetitive peak off-state voltage Repetitive peak reverse voltage	tp=10ms		125	800	1800	V
I_{DRM} I_{RRM}	Repetitive peak current	at V_{DRM} at V_{RRM}		125		120	mA
I_{TSM}	Surge on-state current	10ms half sine wave		125		18	kA
I^2t	I^2t for fusing coordination	$V_R=0.6V_{RRM}$				1620	A ² s*10 ³
V_{TO}	Threshold voltage			125		1.48	V
r_T	On-state slope resistance					0.28	mΩ
V_{TM}	Peak on-state voltage	$I_{TM}=3000A, F=28kN$		125		2.32	V
dv/dt	Critical rate of rise of off-state voltage	$V_{DM}=0.67V_{DRM}$		125		500	V/μs
di/dt	Critical rate of rise of on-state current	$V_{DM}=67\%V_{DRM}$ to 2500A, Gate pulse t _r ≤0.5μs I _{GM} =1.5A		125		1200	A/μs
Q _{rr}	Recovery charge	$I_{TM}=1000A, tp=2000\mu s,$ $di/dt=-60A/\mu s, V_R=50V$		125	800		μC
t _q	Circuit commutated turn-off time	$I_{TM}=1000A, tp=2000\mu s, V_R=50V$ $dv/dt=30V/\mu s, di/dt=-60A/\mu s$		125	18	50	μs
I_{GT}	Gate trigger current				40	300	mA
V_{GT}	Gate trigger voltage	$V_A=12V, I_A=1A$		25	0.9	3.5	V
I_H	Holding current				20	500	mA
V_{GD}	Non-trigger gate voltage	$V_{DM}=67\%V_{DRM}$		125	0.3		V
$R_{th(j-c)}$	Thermal resistance Junction to case	At 180° sine double side cooled				0.016	°C/W
$R_{th(c-h)}$	Thermal resistance case to heat sink	Clamping force 28kN				0.004	
F_m	Mounting force				21	30	kN
T _{stg}	Stored temperature				-40	140	°C
W _t	Weight					640	g
Outline							

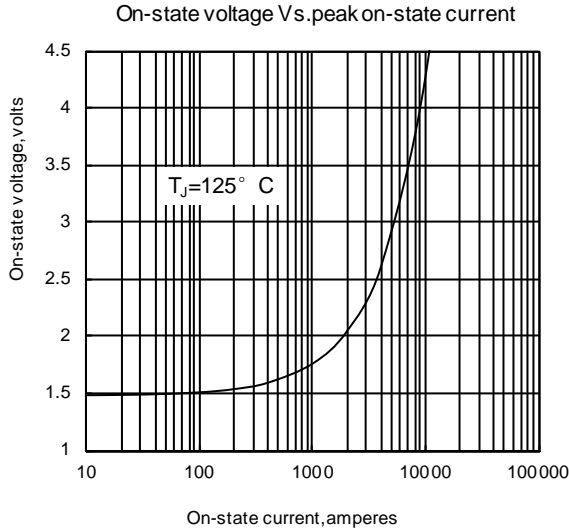


Fig1

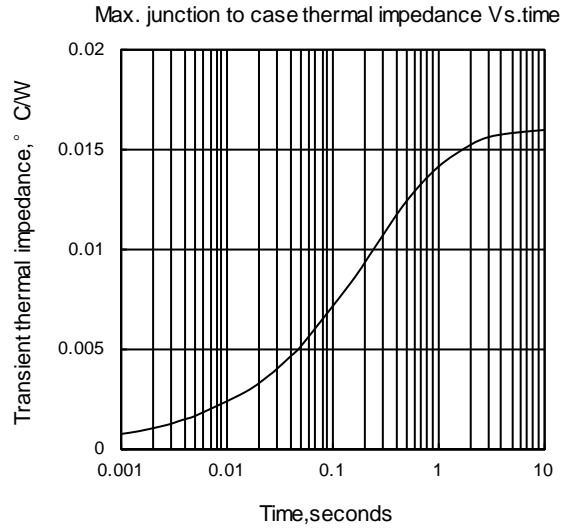


Fig2

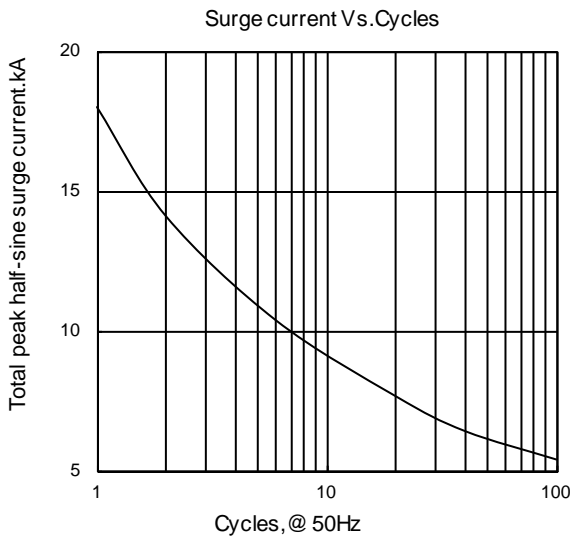


Fig3

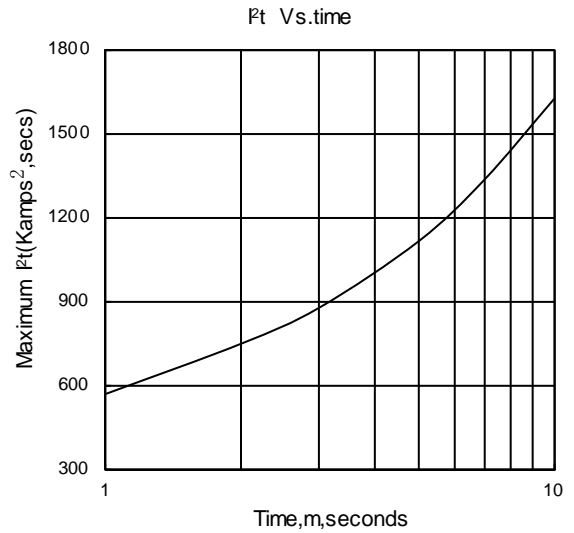


Fig4

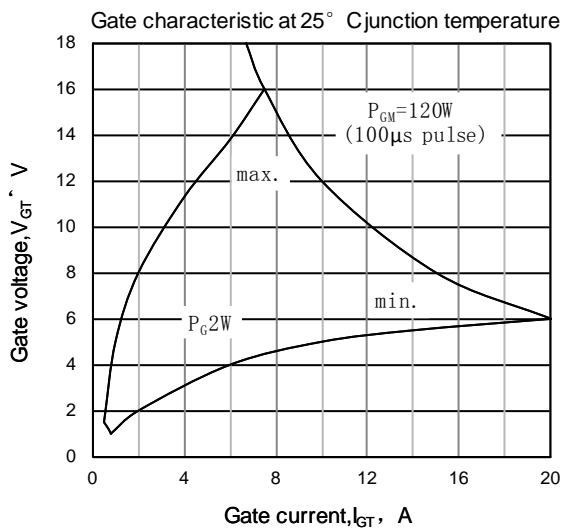


Fig5

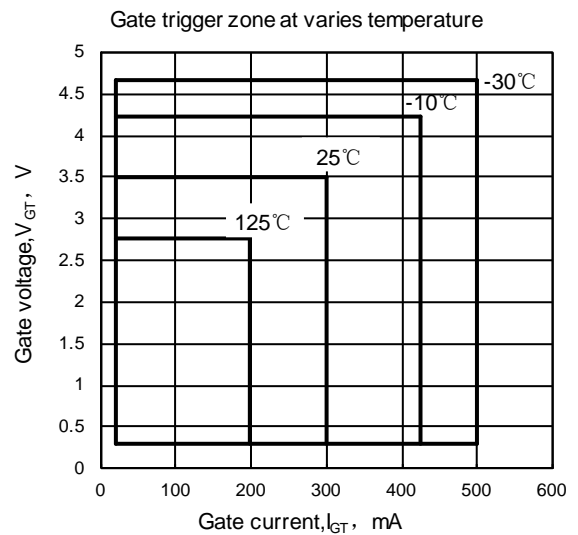


Fig6

Outline:

